

FV6700 Bonding Film for PTFE Multilayer Applications

Metclad type FV6700 Bonding Film is a high quality, thermoplastic, fluorinated, chlorinated film which has been specifically developed for use as the bonding agent to stripline packages and other multilayer circuits made from PTFE laminates. FV6700 has a low dielectric constant, a low dissipation factor and high dielectric strength.

| Typical Parameter | Typical Value |
|----------------------------------|--|
| Dielectric Constant | 2.35 ±0.1 |
| Dissipation Factor | 0.0025 |
| Thickness | 38µm (0.0015″) |
| Laminaing Temperature | 238°C |
| Dielectric Breakdown | 3.75kV |
| Volume Resistivity (+28°C/+77°C) | 10^{12} M Ω /cm |
| Surface Resistivity | 10 ¹⁰ ΜΩ |
| Arc Resisance | 130 sec |
| Dimensions: Widths Length | 305mm, 610mm up tp 9,144mm (rolled) |

The above represents typical values. As a policy of continuous improvement, Metclad International Corp. reserves the right to change specifications at any time.